

LM3702/LM3703

Microprocessor Supervisory Circuits with Low Line Output and Manual Reset

General Description

The LM3702/LM3703 series of microprocessor supervisory circuits provide the maximum flexibility for monitoring power supplies and battery controlled functions in systems without backup batteries. The LM3702/LM3703 series are available in a 9-bump micro SMD package.

Built-in features include the following:

Reset: Reset is asserted during power-up, power-down, and brownout conditions. $\overline{\text{RESET}}$ is guaranteed down to V_{CC} of 1.0V.

Manual Reset Input: An input that asserts reset when pulled low.

Low Line Output: This early power failure warning indicator goes low when the supply voltage drops to a value which is 2% higher than the reset threshold voltage.

Features

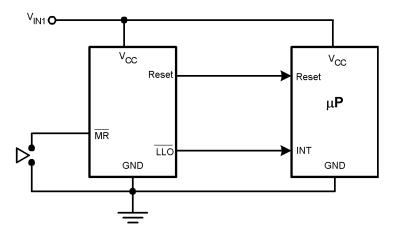
- Standard Reset Threshold voltage: 3.08V
- Custom Reset Threshold voltages: For other voltages between 2.2V and 5.0V in 10mV increments, contact National Semiconductor Corp.

- No external components required
- Manual-Reset input
- RESET (LM3702) or RESET (LM3703) outputs
- Precision supply voltage monitor
- Factory programmable Reset Timeout Delay
- Available in micro SMD package for minimum footprint
- ±0.5% Reset threshold accuracy at room temperature
- ±2% Reset threshold accuracy over temperature extremes
- Reset assertion down to 1V V_{CC} (RESET option only)
- 28 µA V_{CC} supply current

Applications

- Embedded Controllers and Processors
- Intelligent Instruments
- Automotive Systems
- Critical µP Power Monitoring

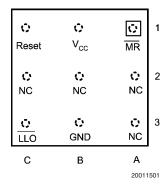
Typical Application



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Connection Diagram

Top View (looking from the coating side) micro SMD 9 Bump Package BPA09

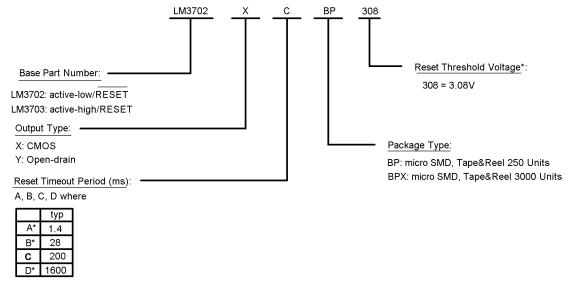


Pin Descriptions

Bump No.	Name	Function
A1	MR	Manual-Reset input. When MR is less than V _{MRT} (Manual Reset Threshold)
		RESET/RESET is engaged.
B1	V _{CC}	Power Supply input.
C1	RESET	Reset Logic Output. Pulses low for t _{RP} (Reset Timeout Period) when triggered, and stays
		low whenever V_{CC} is below the reset threshold or when \overline{MR} is below V_{MRT} . It remains low
		for t_{RP} after either V_{CC} rises above the reset threshold, or after \overline{MR} input rises above
		V _{MRT} (LM3702 only).
	RESET	Reset Logic Output. RESET is the inverse of RESET (LM3703 only).
C3	LLO	Low-Line Logic Output. Early Power-Fail warning output. Low when V _{CC} falls below V _{LLOT}
		(Low-Line Output Threshold). This output can be used to generate an NMI (Non-Maskable
		Interrupt) to provide an early warning of imminent power-failure.
В3	GND	Ground reference for all signals.
A2, A3, C2	NC	No Connect.
B2	NC	No Connect. Test input used at factory only. Leave floating.

Block Diagram V_{cc}**o-**OPEN for 'Y' versions; CONNECT for 'X' Reset Comparator versions RESET/RESET OUTPUT Reset Logic and One-Shot Timer Low Line Comparator 56k 1.225V Reference Manual Reset Comparator MR O-20011505

Ordering Information



^{* =} available upon request. Contact National Semiconductor

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LM3702/LM3703

Part Number	Output	Reset Timeout Period	Package Marking
LM3702XCBP-308	totem-pole	200ms	%%l2
LM3702XCBPX-308	totem-pole	200ms	%%l2
LM3703XCBP-308	totem-pole	200ms	%%l3
LM3703XCBPX-308	totem-pole	200ms	%%l3
LM3703XDBP-308	totem-pole	1600ms	%%124
LM3703XDBPX-308	totem-pole	1600ms	%%124
LM3702YABP-308	open-drain	1.4ms	%%131
LM3702ABPX-308	open-drain	1.4ms	%%131
LM3702YDBP-220	open-drain	1600ms	%%125
LM3702YDBPX-220	open-drain	1600ms	%%125

^{%%} is the datecode and will vary with time.

Table Of Functions

Part Number	Active Low Reset	Active High Reset	Output (X = totem-pole) (Y = open-drain)	Reset Timeout Period	Manual Reset	Low Line Output
LM3702	х		X, Y*	Customized	х	х
LM3703		х	X	Customized	х	х

 $^{^*}$ = available upon request. Contact National

^{*}For other voltages between 2.2V and 5.0V, please contact National Semiconductor sales office.

(Note 3)

Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

Operating Ratings (Note 1)

Power Dissipation

Temperature Range $-40^{\circ}\text{C} \le \text{T}_{\text{J}} \le 85^{\circ}\text{C}$

Supply Voltage (V_{CC}) -0.3V to 6.0V

All Other Inputs -0.3V to V_{CC} + 0.3V

ESD Ratings (Note 2)

Human Body Model 1.5kV Machine Model 150V

LM3702/LM3703 Series Electrical Characteristics

Limits in the standard typeface are for $T_J = 25^{\circ}C$ and limits in **boldface type** apply over full operating range. Unless otherwise specified: $V_{CC} = +2.2V$ to 5.5V.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
POWER S	UPPLY					
V _{CC}	Operating Voltage	LM3702	1.0		5.5	V
	Range: V _{CC}	LM3703	1.2		5.5	7 V
I _{cc}	V _{CC} Supply Current	All inputs = V _{CC} ; all outputs floating		28	50	μА
RESET TH	RESHOLD					•
V _{RST}	Reset Threshold	V _{CC} falling	-0.5		+0.5	
			-2	V _{RST}	+2	%
		V _{CC} falling: T _A = 0°C to 70°C	-1.5	1	+1.5	
V _{RSTH}	Reset Threshold Hysteresis			0.0032•V _{RST}		mV
t _{RP}	Reset Timeout	Reset Timeout Period = A	1	1.4	2	
	Period	Reset Timeout Period = B	20	28	40	ms
		Reset Timeout Period = C	140	200	280	1115
		Reset Timeout Period = D	1120	1600	2240	
t _{RD}	V _{CC} to Reset Delay	V _{CC} falling at 1mV/µs		20		μs
RESET (LI	M3703)		•	,		•
V _{OL}	RESET	$V_{CC} > 2.25V, I_{SINK} = 900\mu A$			0.3	
		V _{CC} > 2.7V, I _{SINK} = 1.2mA			0.3	V
		V _{CC} > 4.5V, I _{SINK} = 3.2mA			0.4	1
V _{OH}	RESET	$V_{CC} > 1.2V$, $I_{SOURCE} = 50\mu A$	0.8 V _{CC}			
		V _{CC} > 1.8V, I _{SOURCE} = 150μA	0.8 V _{CC}			1
		V _{CC} > 2.25V, I _{SOURCE} = 300μA	0.8 V _{CC}			V
		V _{CC} > 2.7V, I _{SOURCE} = 500μA	0.8 V _{CC}			1
		V _{CC} > 4.5V, I _{SOURCE} = 800μA	V _{CC} - 1.5V			
I _{LKG}	Output Leakage Current	V _{RESET} = 5.5V			1.0	μА
RESET (LI	M3702)		'	,		'
V _{OL}	RESET	$V_{CC} > 1.0V, I_{SINK} = 50\mu A$			0.3	
OL.		$V_{CC} > 1.2V$, $I_{SINK} = 100\mu A$			0.3	1
		$V_{CC} > 2.25V$, $I_{SINK} = 900\mu A$			0.3	1
		$V_{CC} > 2.7V$, $I_{SINK} = 1.2mA$			0.3	1
		$V_{\rm CC} > 4.5 \text{V}, I_{\rm SINK} = 3.2 \text{mA}$			0.4	V
V _{OH}	RESET	$V_{CC} > 2.25V$, $I_{SOURCE} = 300\mu A$	0.8 V _{CC}			1
OII		$V_{CC} > 2.7V$, $I_{SOURCE} = 500\mu A$	0.8 V _{CC}			1
	1	$V_{CC} > 4.5V$, $I_{SOURCE} = 800\mu A$	V _{CC} - 1.5V			+

LM3702/LM3703 Series Electrical Characteristics (Continued)

Limits in the standard typeface are for $T_J = 25^{\circ}C$ and limits in **boldface type** apply over full operating range. Unless otherwise specified: $V_{CC} = +2.2V$ to 5.5V.

Symbol	Parameter	Conditions	Min	Тур	Max	Units
MR			'		•	
V_{MRT}	MR Input	MR, Low			0.8	V
	Threshold	MR, High	2.0			V
V_{MRTH}	MR Threshold	$\overline{\text{MR}}$ falling: $V_{\text{CC}} = V_{\text{RST MAX}}$ to 5.5V	MR falling: V _{CC} = V _{RST MAX} to 5.5V 0.0032•\			mV
	Hysteresis					
R _{MR}	MR Pull-up		35	56	75	kΩ
	Resistance					
t_{MD}	MR to Reset			12		μS
	Delay					
t _{MR}	MR Pulse Width		25			μS
LLO						
V _{OL}	LLO Output	$V_{CC} > 2.25V, I_{SINK} = 900\mu A$			0.3	
	Voltage	V _{CC} > 2.7V, I _{SINK} = 1.2mA			0.3	
		$V_{CC} > 4.5V, I_{SINK} = 3.2mA$			0.4	V
V _{OH}		$V_{\rm CC} > 2.25 \text{V}, I_{\rm SOURCE} = 300 \mu \text{A}$	0.8 V _{CC}			V
		$V_{\rm CC} > 2.7 \text{V}$, $I_{\rm SOURCE} = 500 \mu \text{A}$	0.8 V _{CC}			
		$V_{CC} > 4.5V$, $I_{SOURCE} = 800\mu A$	V _{cc} - 1.5V			
LLO OUTP	TUT				•	
V _{LLOT}	LLO Output		1.01•V _{RST}	1.02•V _{RST}	1.03•V _{RST}	V
	Threshold					
	$(V_{LLO} - V_{RST}, V_{CC})$					
	falling)					
V_{LLOTH}	Low-Line			0.0032•V _{RST}		mV
	Comparator					
	Hysteresis					
t_{CD}	Low-Line	V _{CC} falling at 1mV/μs		20		μs
	Comparator Delay					

Note 1: Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is intended to be functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed conditions

Note 2: The Human Body model is a 100 pF capacitor discharged through a 1.5 k Ω resistor into each pin. The machine model is a 200pF capacitor discharged directly into each pin.

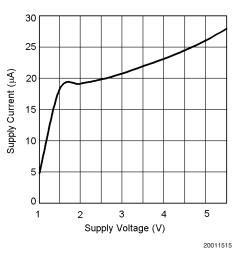
Note 3: The maximum allowable power dissipation is a function of the maximum junction temperature, $T_J(MAX)$, the junction-to-ambient thermal resistance, θ_{J-A} , and the ambient temperature, T_A . The maximum allowable power dissipation at any ambient temperature is calculated using:

$$P(MAX) = \frac{T_J(MAX) - T_A}{\theta_{J-A}}$$

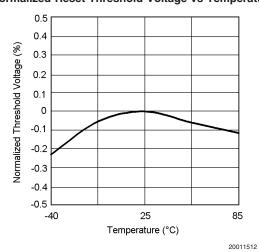
Where the value of $\theta_{\text{J-A}}$ for the micro SMD package is 220°C/W.

Typical Performance Characteristics

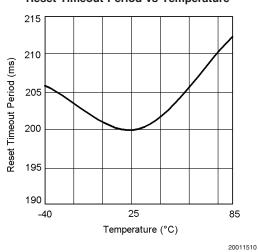
Supply Current vs Supply Voltage



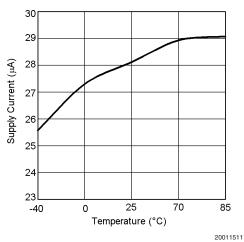
Normalized Reset Threshold Voltage vs Temperature



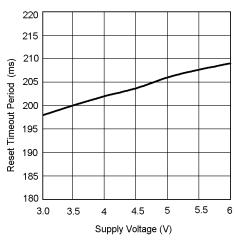
Reset Timeout Period vs Temperature



3.3V Supply Current vs Temperature

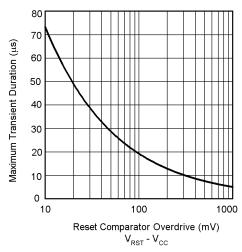


Reset Timeout Period vs V_{CC}



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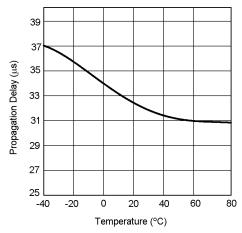
Max. Transient Duration vs Reset Comparator Overdrive ($V_{\text{CC}} = 3.3\text{V}$)



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Typical Performance Characteristics (Continued)

Low-Line Comparator Propagation Delay vs Temperature



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Circuit Information

RESET OUTPUT

The Reset input of a μP initializes the device into a known state. The LM3702/LM3703 microprocessor supervisory circuits assert a forced reset output to prevent code execution errors during power-up, power-down, and brownout conditions.

RESET is guaranteed valid for $V_{CC} > 1V$. Once V_{CC} exceeds the reset threshold, an internal timer maintains the output for the reset timeout period. After this interval, reset goes high. The LM3702 offers an active-low \overline{RESET} ; The LM3703 offers an active-high RESET.

Any time $V_{\rm CC}$ drops below the reset threshold (such as during a brownout), the reset activates. When $V_{\rm CC}$ again rises above the reset threshold, the internal timer starts. Reset holds until $V_{\rm CC}$ exceeds the reset threshold for longer than the reset timeout period. After this time, reset releases.

The Manual Reset input (\overline{MR}) will initiate a forced reset also. See the *Manual Reset Input* section.

RESET THRESHOLD

The LM3702/LM3703 family is available with a reset voltage of 3.08V. Other reset thresholds in the 2.20V to 5.0V range, in steps of 10 mV, are available; contact National Semiconductor for details.

MANUAL RESET INPUT (MR)

Many μP -based products require a manual reset capability, allowing the operator to initiate a reset. The \overline{MR} input is fully debounced and provides an internal 56 k Ω pull-up. When the \overline{MR} input is pulled below V_{MRT} (1.225V) for more than 25 μs , reset is asserted after a typical delay of 12 μs . Reset remains active as long as \overline{MR} is held low, and releases after the reset

timeout period expires after $\overline{\text{MR}}$ rises above V_{MRT} . Use $\overline{\text{MR}}$ with digital logic to assert or to daisy chain supervisory circuits. It may be used as another low-line comparator by adding a buffer.

LOW-LINE OUTPUT (LLO)

The low-line output comparator is typically used to provide a non-maskable interrupt to a μP when V_{CC} begins falling. \overline{LLO} monitors V_{CC} and goes low when V_{CC} falls below V_{LLOT} (typically 1.02 • V_{RST}) with hysteresis of 0.0032 • V_{RST} .

SPECIAL PRECAUTIONS FOR THE MICRO SMD PACKAGE

As with most integrated circuits, the LM3702 and LM3703 are sensitive to exposure from visible and infrared (IR) light radiation. Unlike a plastic encapsulated IC, the micro SMD package has very limited shielding from light, and some sensitivity to light reflected from the surface of the PC board or long wavelength IR entering the die from the side may be experienced. This light could have an unpredictable affect on the electrical performance of the IC. Care should be taken to shield the device from direct exposure to bright visible or IR light during operation.

MICRO SMD MOUNTING

The micro SMD package requires specific mounting techniques which are detailed in National Semiconductor Application Note AN-1112. Referring to the section *Surface Mount Technology (SMT) Assembly Considerations*, it should be noted that the pad style which must be used with the 9-pin package is the NSMD (non-solder mask defined) type.

For best results during assembly, alignment ordinals on the PC board may be used to facilitate placement of the micro SMD device.

Timing Diagrams

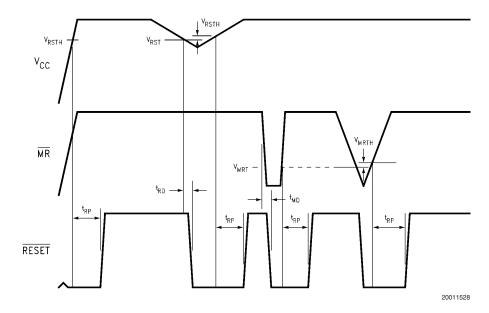


FIGURE 1. LM3702 Reset Time with $\overline{\text{MR}}$

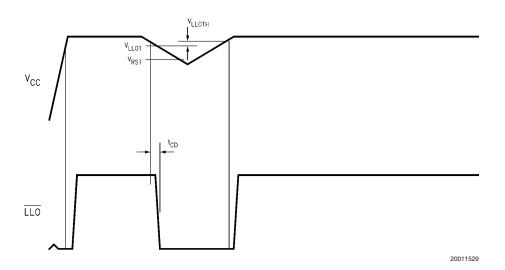


FIGURE 2. LLO Output

Typical Application Circuits

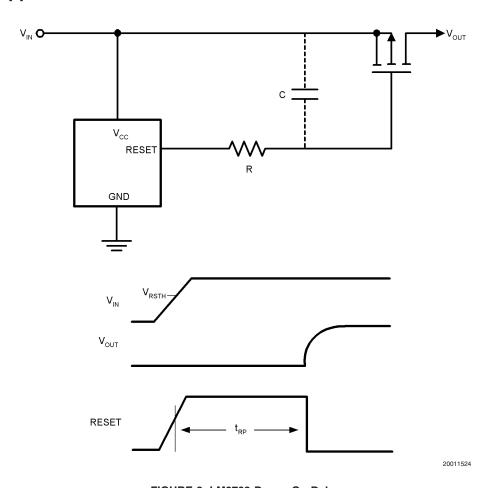


FIGURE 3. LM3703 Power-On Delay

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Typical Application Circuits (Continued)

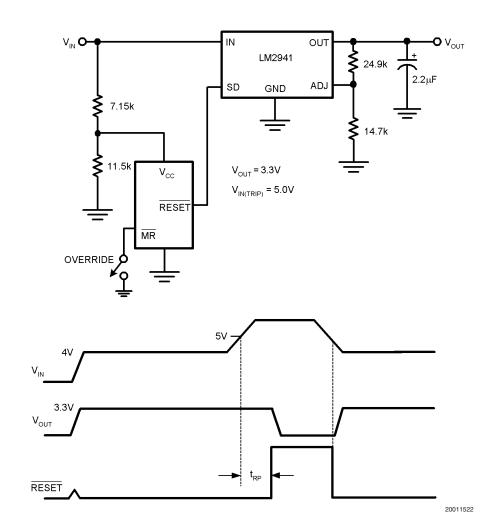


FIGURE 4. Regulator/Switch with Long-Term Overvoltage Lockout Prevents Overdissipation in Linear Regulator

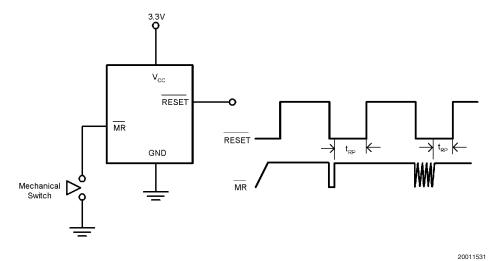
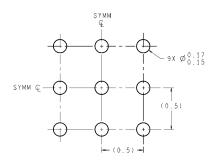


FIGURE 5. Switch Debouncer

www.national.com 12

Physical Dimensions inches (millimeters)

unless otherwise noted



DIMENSIONS ARE IN MILLIMETERS

LAND PATTERN RECOMMENDATION В SYMM TOP SIDE COATING-SYMM BUMP A1 CORNER STI LCON-BPA09XXX (Rev D)

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. EPOXY COATING
- 2. 63Sn/37Pb EUTECTIC BUMP
- 3. RECOMMEND NON-SOLDER MASK DEFINED LANDING PAD.
- 4. PIN 1 IS ESTABLISHED BY LOWER LEFT CORNER WITH RESPECT TO TEXT ORIENTATION. REMAINING PINS ARE NUMBERED COUNTER CLOCKWISE.
- 5. XXX IN DRAWING NUMBER REPRESENTS PACKAGE SIZE VARIATION WHERE X1 IS PACKAGE WIDTH, X2 IS PACKAGE LENGTH AND X3 IS PACKAGE HEIGHT.

6.NO JEDEC REGISTRATION AS OF AUG.1999.

9 bump micro SMD Package **NS Package Number BPA09FFB** The dimensions of X1, X2 and X3 are given below X1 = 1.412mm X2 = 1.412mmX3 = 0.850mm

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- 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.



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